	© Copyright 2005. IPO international and Pan-	Material Composition Declaration  © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both nternational and Pan-American copyright conventions.			der both level	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.							
52-21.1	IPC Web Site for Information on IPC-1752 Standard Form Typhttp://www.ipc.org/IPC-175x Distribute				Form Type * Distribute	e * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				ials and Mfg Information			
applier Inform	nation												
Company name*			Company unique ID			Un	nique ID Author	rity		Response Date*			
onsemi										2024-04-28			
Contact Name			Title - Contact			Ph	Phone - Contact*			Email - Contact*			
roduct-Env-Stewa	ards		Product Enviro Compliance			N.	NA			Product-Env-Stewards@onsemi.com			
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Product-Env-Stewards			Product Enviro Compliance			N.	NA			Product-Env-Stewards@onsemi.com			
Requeste	er Item Number	Mfr Item Number		Mfr Item Name		Е	Effective Date	Version	Manufacturing Site	Weight*	UOM	Unit Type	
	2SC4134S-		S-TL-E	TL-E BIP NPN 1A 100V		20	024-04-28		CNG	280.84	mg	Each	
	Plating / Grid Array Mat		arminal Daga	Alloy	STD-020 MSL Rati	ina	Dook Process	s Body Tempera	ature Max Time at Peak	Tamparatura Num	ber of Reflow Cy	alas	
			Terminal Base Alloy J-STI CU Alloy 1		STD-020 MSL Kau	ing	260	S Body Tellipers	30	seconds 3	ber of Kerlow Cy	cies	
	DI	C	O Alloy	1			200	<u> </u>	30	seconds 3			
omments	ime at peak temperatur	o during sale	doring is 10	20 seconds									
	ıme at peak temperatur on regarding material c												

RoHS Material Composition Declaration			Declaration Type *	Detailed					
RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and cornel to the best of its knowledges that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms andConditions of Sale applicable to such part shall apply.									
RoHS Declaration * 4 - Item(s	) does not contain RoHS restricted substance	s per the definition above except for selected exemp	tions Supplier Acceptance	* Accepted					
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).									
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
Instructions: Complete all of the required f Requester) and click on Submit Form to ha		Accepted" on the Supplier Acceptance drop-dow	n. This will display the signature area. Digita	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	astislav Drska	-En							

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.33	mg	Supplier	Silicon (Si)	7440-21-3		0.33	mg
Die Attach Solder	0.15	mg	Supplier	Silver (Ag)	7440-22-4		0.0038	mg
			A	Lead (Pb)	7439-92-1	7a	0.1388	mg
			Supplier	Tin (Sn)	7440-31-5		0.0075	mg
Lead Frame	146.46	mg	Supplier	Silver (Ag)	7440-22-4		0.3808	mg
			Supplier	Tin (Sn)	7440-31-5		0.205	mg
			Supplier	Copper (Cu)	7440-50-8		145.8742	mg
Mold Compound-Black	130.38	mg		Brominated epoxy resin	proprietary data		1.8253	mg
			Supplier	Epoxy Phenol Resin	Proprietary Data		5.8671	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		1.1734	mg
			Supplier	Carbon Black (C)	1333-86-4		1.3038	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		97.785	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		22.1646	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		0.2608	mg
Plating	3.34	mg	В	Bismuth (Bi)	7440-69-9		0.02	mg
-			Supplier	Tin (Sn)	7440-31-5		3.32	mg
Wire Bond - Au	0.18	mg	Supplier	Gold (Au)	7440-57-5		0.18	mg